

VOLTAGE DETECTORS

FEATURES

- Qualified for Automotive Applications
- Single Voltage Detector (TPS3803): Adjustable/1.5 V
- Dual Voltage Detector (TPS3805): Adjustable/3.3 V
- High ±1.5% Threshold Voltage Accuracy
- Supply Current: 3 μA Typical at V_{DD} = 3.3 V
- Push/Pull Reset Output (TPS3805),
 Open-Drain Reset Output (TPS3803)
- Temperature Range: –40°C to 125°C
- 5-Pin SC-70 Package

DESCRIPTION

The TPS3803 and TPS3805 families of supervisory circuits provide circuit initialization and timing supervision, primarily for DSPs and processor-based systems.

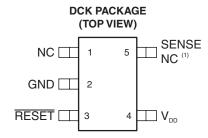
The TPS3803G15 device has a fixed-sense threshold voltage $V_{\rm IT}$ set by an internal voltage divider, whereas the TPS3803-01 has an adjustable SENSE input that can be configured by two external resistors. In addition to the fixed sense threshold monitored at $V_{\rm DD}$, the TPS3805 devices provide a second adjustable SENSE input. RESET is asserted in case either of the two voltages drops below $V_{\rm IT}$.

During power on, \overline{RESET} is asserted when supply voltage V_{DD} becomes higher than 0.8 V. Thereafter, the supervisory circuit monitors V_{DD} (and/or SENSE) and keeps \overline{RESET} active as long as V_{DD} or SENSE remains below the threshold voltage V_{IT} . As soon as V_{DD} (SENSE) rises above the threshold voltage V_{IT} , \overline{RESET} is deasserted again. The product spectrum is designed for 1.5 V, 3.3 V, and adjustable supply voltages.

The devices are available in a 5-pin SC-70 package. The TPS3803 and TPS3805 devices are characterized for operation over a temperature range of -40°C to 125°C.

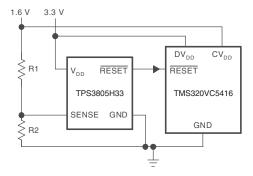
APPLICATIONS

- Applications Using DSPs, Microcontrollers, or Microprocessors
- Wireless Communication Systems
- Portable/Battery-Powered Equipment
- Programmable Controls
- Intelligent Instruments
- Industrial Equipment
- Notebook/Desktop Computers
- Automotive Systems



NC - No connection

(1) SENSE on TPS3803-01, TPS3805H33 NC on TPS3803G15





Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.





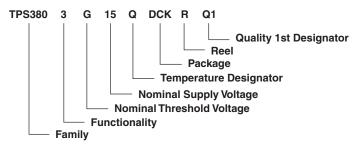
This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

ORDERING INFORMATION(1)

-	THRESHOLD VOLTAGE		PACKAGE ⁽²⁾		ORDERABLE PART	TOP-SIDE
T _A	V _{DD}	SENSE	PACKAGE		NUMBER	MARKING
	NA	1.226 V			TPS3803-01QDCKRQ1	AWJ
-40°C to 125°C	1.4 V	NA	SC-70 - DCK	Reel of 3000	TPS3803G15QDCKRQ1	AXU
	3.05 V	1.226 V			TPS3805H33QDCKRQ1	AWZ

- (1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.
- (2) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.



FUNCTION/TRUTH TABLE

TPS3803-01		
SENSE > VIT	RESET	
0	L	
1	Н	

FUNCTION/TRUTH TABLE

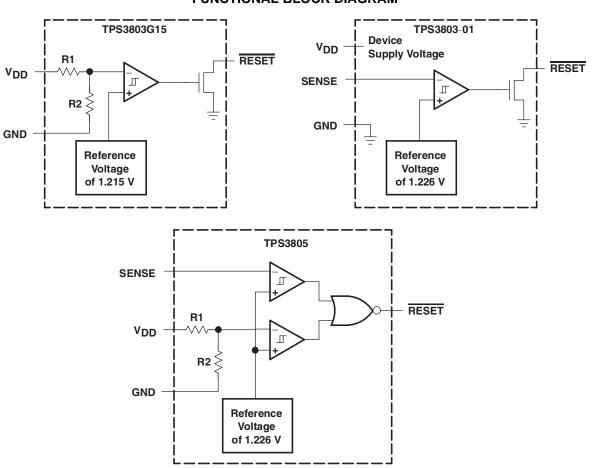
TPS3803G15		
$V_{DD} > V_{IT}$	RESET	
0	L	
1	Н	

FUNCTION/TRUTH TABLE

	TPS3805H33	
$V_{DD} > V_{IT}$	SENSE > V _{IT}	RESET
0	0	L
0	1	L
1	0	L
1	1	Н

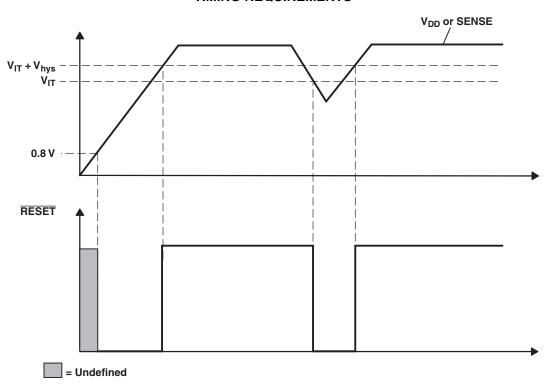


FUNCTIONAL BLOCK DIAGRAM





TIMING REQUIREMENTS



TERMINAL FUNCTIONS

TERMINAL		1/0	DESCRIPTION	
NAME	NO.	I/O	DESCRIPTION	
GND	2	I	Ground	
RESET	3	0	Active-low reset output (TPS3803: open drain, TPS3805: push/pull)	
SENSE	5	I	Adjustable sense input	
NC	1		No internal connection	
NC (TPS3803G15)	5		No internal connection	
V_{DD}	4	I	Input supply voltage, fixed sense input for TPS3803G15 and TPS3805	



ABSOLUTE MAXIMUM RATINGS(1)

over operating free-air temperature range (unless otherwise noted)

			VALUE
V_{DD}	Supply voltage ⁽²⁾		7 V
	Voltage applied to all other pins ⁽²⁾	–0.3 V to 7 V	
I _{OL}	Maximum low-level output current		5 mA
I _{OH}	Maximum high-level output current		–5 mA
I _{IK}	Input clamp current $V_I < 0$ or $V_I > V_{DD}$		±10 mA
I _{OK}	Output clamp current	$V_O < 0$ or $V_O > V_{DD}$	±10 mA
P _D	Continuous total power dissipation		See Dissipation Rating Table
T _A	Operating free-air temperature range		-40°C to 125°C
T _{stg}	Storage temperature range		−65°C to 150°C
T _{solder}	Soldering temperature		260°C

⁽¹⁾ Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

DISSIPATION RATINGS

PACKAGE	POWER RATING	DERATING FACTOR	POWER RATING	POWER RATING
	T _A < 25°C	ABOVE T _A = 25°C	T _A = 70°C	T _A = 85°C
DCK	321 mW	2.6 mW/°C	206 mW	167 mW

RECOMMENDED OPERATING CONDITIONS

		MIN	MAX	UNIT
V_{DD}	Supply voltage	1.3	6	V
VI	Input voltage	0	$V_{DD} + 0.3$	V
T_A	Operating free-air temperature	-40	125	°C

⁽²⁾ All voltage values are with respect to GND. For reliable operation, the device should not be continuously operated at 7 V for more than t = 1000 h.



ELECTRICAL CHARACTERISTICS

over operating free-air temperature range (unless otherwise noted)

	PARAM	ETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
			$V_{DD} = 1.5 \text{ V}, I_{OH} = -0.5 \text{ mA}$				
V_{OH}	High-level output voltag	e (TPS3805 only)	$V_{DD} = 3.3 \text{ V}, I_{OH} = -1 \text{ mA}$	$0.8 \times V_{DD}$			V
			$V_{DD} = 6 \text{ V}, I_{OH} = -1.5 \text{ mA}$				
			V _{DD} = 1.5 V, I _{OL} = 1 mA				
V_{OL}	Low-level output voltage	е	$V_{DD} = 3.3 \text{ V}, I_{OL} = 2 \text{ mA}$			0.3	V
			$V_{DD} = 6 \text{ V}, I_{OL} = 3 \text{ mA}$				
	Power-up reset voltage ⁽¹⁾		$V_{IT} > 1.5 \text{ V}, T_A = 25^{\circ}\text{C}$	0.8			V
	Power-up reset voltage	()	$V_{IT} \le 1.5 \text{ V}, T_A = 25^{\circ}\text{C}$	1			V
		SENSE		1.2	1.226	1.244	
V_{IT}	, Negative-going input threshold voltage (2)	TPS3803G15		1.379	1.4	1.421	V
	unconoid voltage	TPS3805H33		3.004	3.05	3.096	
.,	Dhartana da	1	1.2 V < V _{IT} < 2.5 V		15		
V_{hys}	Hysteresis		2.5 V < V _{IT} < 3.5 V		30		mV
I	Input current	SENSE		-25		25	nA
I _{OH}	High-level output current at RESET	Open drain only	V _{DD} = V _{IT} + 0.2 V, V _{OH} = V _{DD}			300	nA
		TPS3803-01	V 00V 0 · · ·		2	4	
	I _{DD} Supply current	TPS3805, TPS3803G15	V _{DD} = 3.3 V, Output unconnected		3	5	
I _{DD}		TPS3803-01	V 0 V 0 de		2	4	μΑ
		TPS3805, TPS3803G15	V _{DD} = 6 V, Output unconnected		4	6	
C _I	Input capacitance	1	$V_I = 0 V \text{ to } V_{DD}$		1		pF

TIMING REQUIREMENTS

 R_L = 1 MΩ, C_L = 50 pF, T_A = $-40^{\circ}C$ to 125°C (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT	
	Pulse duration	V_{DD}	V - 105 x V V - 0.05 x V	.		5
ι _W	ruise duration	SENSE	$V_{IH} = 1.05 \times V_{IT}, V_{IL} = 0.95 \times V_{IT}$	5.5		μs

SWITCHING CHARACTERISTICS

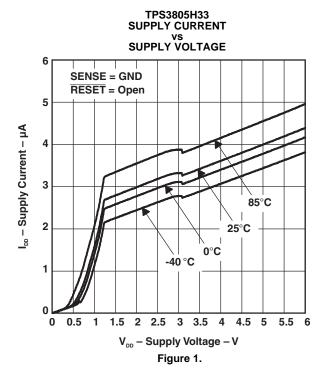
 R_L = 1 MΩ, C_L = 50 pF, T_A = $-40^{\circ}C$ to 125°C (unless otherwise noted)

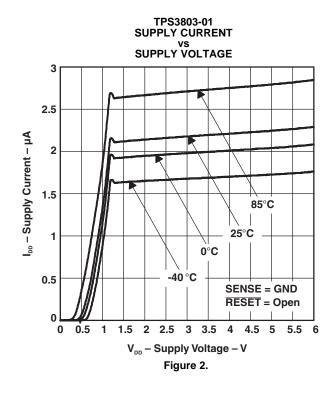
PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT	
t _{PHL}	Propagation (delay) time, high-to-low-level output	V _{DD} to RESET delay SENSE to RESET delay	$V_{IH} = 1.05 \times V_{IT}, V_{IL} = 0.95 \times V_{IT}$		5	100	μs
t _{PLH}	Propagation (delay) time, low-to-high-level output	V _{DD} to RESET delay SENSE to RESET delay	$V_{IH} = 1.05 \times V_{IT}, V_{IL} = 0.95 \times V_{IT}$		5	100	μs

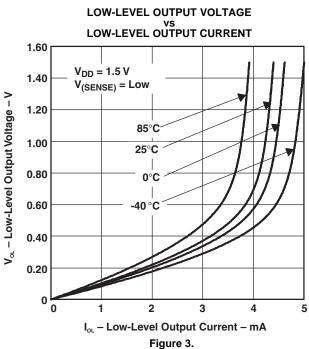
⁽¹⁾ The lowest supply voltage at which $\overline{\text{RESET}}$ ($V_{OL}(\text{max}) = 0.2 \text{ V}$, $I_{OL} = 50 \text{ }\mu\text{A}$) becomes active. $t_r(V_{DD}) \ge 15 \text{ }\mu\text{s/V}$. (2) To ensure the best stability of the threshold voltage, place a bypass capacitor (ceramic, 0.1 μF) near the supply terminals.

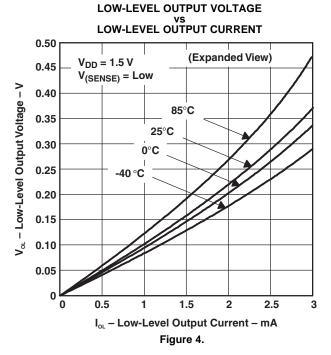


TYPICAL CHARACTERISTICS



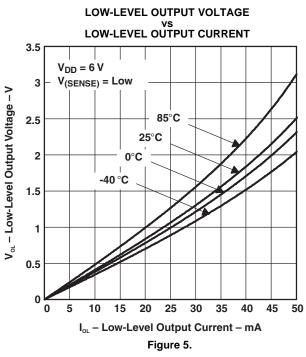








TYPICAL CHARACTERISTICS (continued)



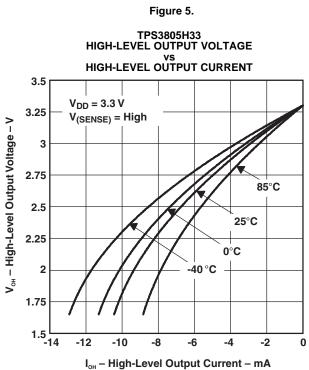
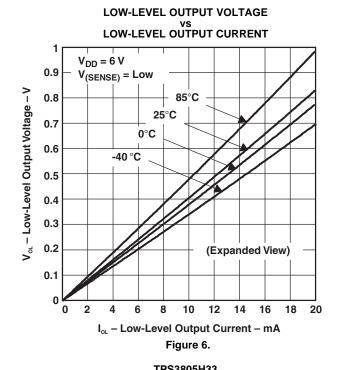
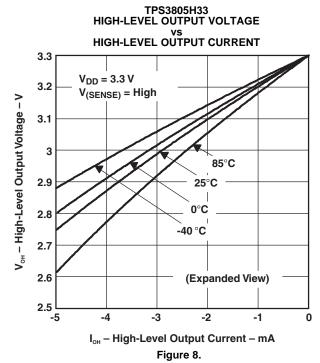


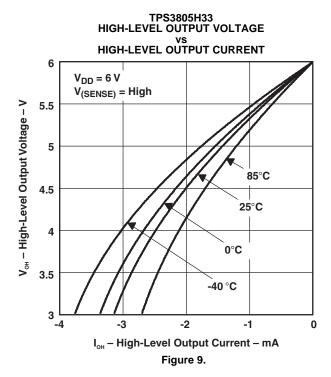
Figure 7.



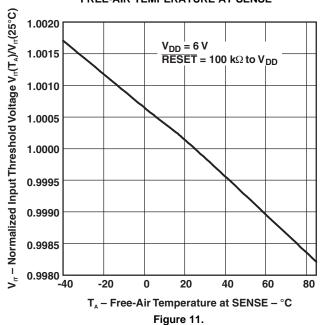




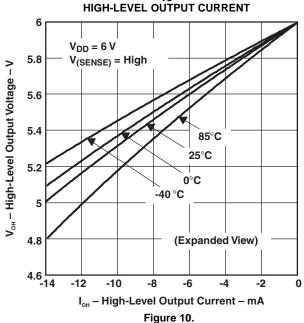
TYPICAL CHARACTERISTICS (continued)







TPS3805H33 HIGH-LEVEL OUTPUT VOLTAGE VS HIGH-LEVEL OUTPUT CURRENT



MINIMUM PULSE DURATION AT V_{DD}

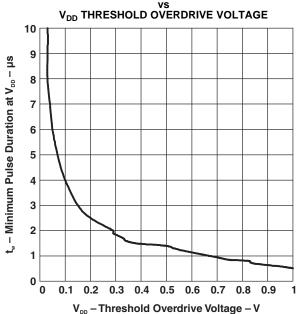
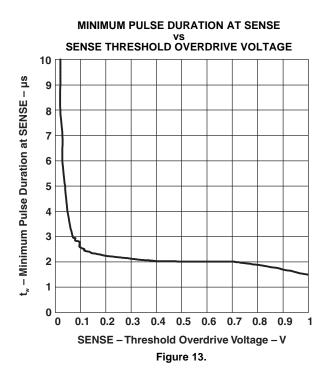
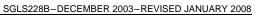


Figure 12.



TYPICAL CHARACTERISTICS (continued)







Revision History

REVISION	PAGE ⁽¹⁾	DESCRIPTION
SGLS228		Initial release
001 00004	1	Update features and description
SGLS228A	3	Update functional block diagram
SGLS228B	1	Update features

⁽¹⁾ Page numbers for previous revitions may differ from page numbers in the current version.





17-Mar-2012

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/ Ball Finish	MSL Peak Temp ⁽³⁾	Samples (Requires Login)
2T03-01QDCKRG4Q1	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
2T03G15QDCKRG4Q	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
2T05H33QDCKRG4Q	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
TPS3803-01QDCKRQ1	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
TPS3803G15QDCKRQ1	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
TPS3805H33QDCKRQ1	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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17-Mar-2012

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF TPS3803-01-Q1, TPS3803G15-Q1, TPS3805H33-Q1:

- Catalog: TPS3803-01, TPS3803G15, TPS3805H33
- Enhanced Product: TPS3803-01-EP, TPS3803G15-EP, TPS3805H33-EP

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Enhanced Product Supports Defense, Aerospace and Medical Applications

DCK (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



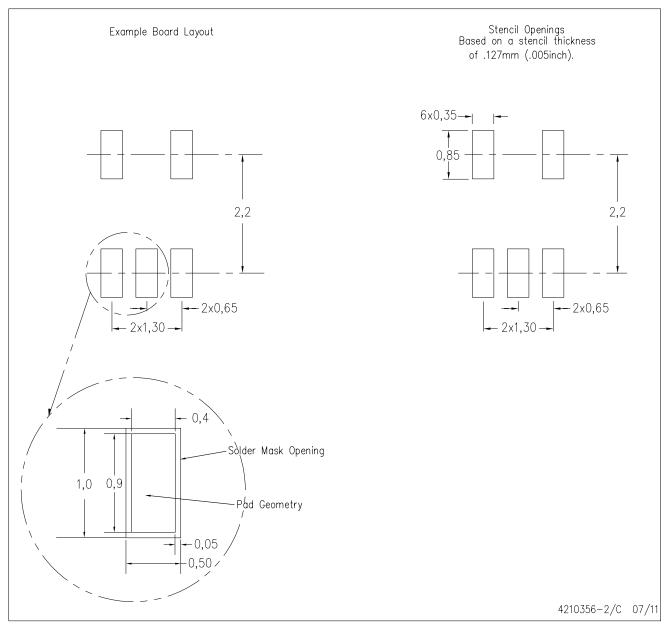
NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
- D. Falls within JEDEC MO-203 variation AA.



DCK (R-PDSO-G5)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
- D. Publication IPC-7351 is recommended for alternate designs.
- E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.



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